

## 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

# Notification# # 20211123002 Marking Standardization for Select Devices Information Only

**Date:** February 17, 2022 **To:** Newark/Farnell PCN

#### Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

# 20211123002.0 Information Only Attachments

#### **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months (60 months for Automotive devices). The corresponding customer part number is also listed, if available.

DEVICE	<b>CUSTOMER PART NUMBER</b>
PCA9539PW	null
SN74AVC20T245DGGR	null
MSP430G2252IPW14	null
CD74HC4053PWR	null
74ACT16245DGGR	null
MSP430G2101IPW14	null
MSP430G2312IPW20	null
MSP430G2211IPW14	null
LM26001MXA/NOPB	null
SN74CB3Q3245PWR	null
MSP430G2302IPW20	null
MSP430G2352IPW20	null
MSP430G2201IPW14R	null
MSP430G2232IPW14	null
TLC59108IPWR	null
TPS40071PWP	null
SN74ACT244PWR	null

Technical details of this Product Change follow on the next page(s).

PCN Nu	mber:	20211123002.0		PCN Date:		te:	February 17, 2022			
Title:	Title: Marking Standardization for Select Devices									
Customer Contact: PCN Manager Dept: Quality Services										
Change Type:										
Asse	embly Site			Assembly Process					Assembly Materials	
Des	ign			Datasheet				Mechanical Specification		
Test	Site		$\boxtimes$	Device Marking				Test Process		
Waf	er Bump Site		Wafer Bump Material				Wafer Bump Process			
Waf	er Fab Site			Wafer Fab Materials				Wafer Fab Process		
				Part nu	ımber ch	ange				

# **PCN Details**

# **Description of Change:**

This notice is to communicate an update in the device symbolization format for the devices in the product affected selection as follows:

	Current	New
**ECAT	Include Value	Remove
TI Bug	Include	Replace with "TI" text
Example	MUX508Q 497G4 C2TX	MUX508Q TD 19 C2TX

<sup>\*\* -</sup> Not all devices have ECAT information included in the symbolization, but for the ones that do, this information will be removed.

# **Reason for Change:**

Marking Standardization

## Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

## **Changes to product identification resulting from this PCN:**

Device symbolization

## **Product Affected:**

See page 2 above

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN ww admin team@list.ti.com

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